



IFW 2823

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re application of: Mostafazadeh et al.

Attorney Docket No.:  
NSC1P226R/P03856R1

Application No.: 10/016,750

Examiner: Unassigned

Filed: December 10, 2001

Group: Unassigned

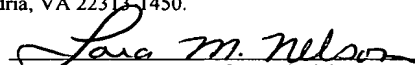
Title: LEAD FRAME DESIGN FOR  
INCREASED CHIP PINOUT

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**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on May 23, 2005 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: \_\_\_\_\_

  
Lara M. Nelson

**REQUEST FOR STATUS**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Applicant hereby requests status of the above-referenced patent application. This application was filed on December 10, 2001 and no response has been received as of this date.

Respectfully submitted,

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